# **Contents**

1	Electrical ratings	3
2	Electrical characteristics	
3	Test circuit	9
4	Package mechanical data	10
5	Packaging mechanical data	14
6	Revision history	15

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	75	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	120	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100°C	120	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	480	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	330	W
	Derating factor	2.2	W/°C
dv/dt (3)	Peak diode recovery voltage slope	20	V/ns
E <sub>AS</sub> (4)	Single pulse avalanche energy	600	mJ
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 175	°C

- 1. Current limited by package
- 2. Pulse width limited by safe operating area
- 3.  $I_{SD} \leq 120 A, \ di/dt \leq 1100 \ A/\mu s, \ V_{DD} \leq 60 V, \ T_J \leq T_{JMAX}$
- 4. Starting  $TJ = 25^{\circ}C$ ,  $I_D = 60A$ ,  $V_{DD} = 25V$

Table 3. Thermal resistance

Symbol	Parameter		Unit		
Symbol	Farameter	TO-220	TO-247	D²PAK	Oiiit
Rthj-case	Thermal resistance junction-case max		0.45		°C/W
Rthj-amb	Thermal resistance junction-ambient max 62.5 50		50		°C/W
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb 50		50	°C/W	
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300		°C	

1. When mounted on 1 inch² FR4 2 oz Cu

# 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions		Min.	Тур.	Max	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$		75			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating, @ 125°C				10 100	μΑ μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 20V$				±200	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2		4	٧
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 60A	TO-220 TO-247 D <sup>2</sup> PAK		3.5 3.2	4 3.7	mΩ mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> =25V, f=1 MHz, V <sub>GS</sub> =0		6750 1080 40		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =37.5V, $I_{D}$ = 120A $V_{GS}$ =10V (see Figure 16)		85 27 26		nC nC nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ =37.5 V, $I_{D}$ = 60A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10V, (see Figure 18)		22 65 100 15		ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)				120 480	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> =120A, V <sub>GS</sub> =0			1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>SD</sub> =120A, V <sub>DD</sub> = 20 V, di/dt = 100 A/µs, Tj=25°C (see Figure 17)		70 150 4.2		ns nC A

<sup>1.</sup> Pulse with limited by safe operating area

**5**//

<sup>2.</sup> Pulsed: pulse duration =  $300\mu s$ , duty cycle 1.5%

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220 / Figure 3. Thermal impedance for TO-220 / TO-247

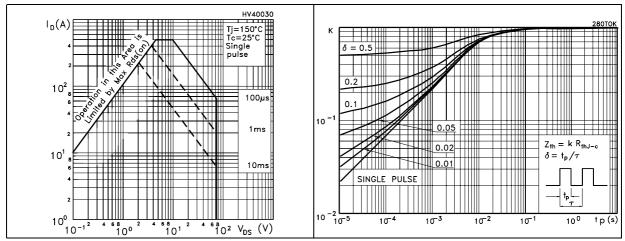


Figure 4. Safe operating area for D2PAK

Figure 5. Thermal impedance for D<sup>2</sup>PAK

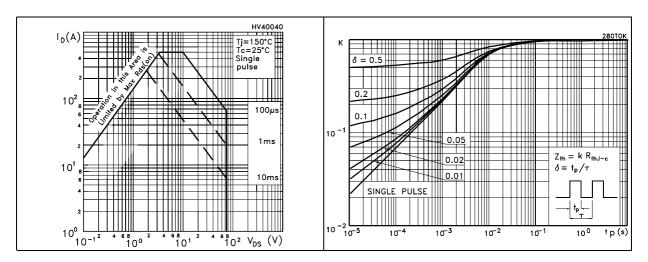
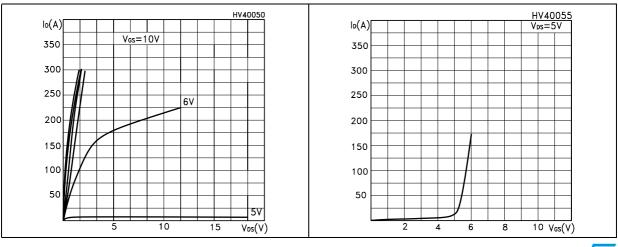


Figure 6. Output characteristics

Figure 7. Transfer characteristics



HV40080 R<sub>DS(on)</sub> V(BR)DSS V<sub>GS</sub>=0  $(m\Omega)$ (norm) lo=250µA 3.7 1.2  $V_{GS} = 10V$ 1.1 3.6 1.0 3.5 3.4 0.9 0.8 ō -50 50 100 TJ(°C) 30 60 90 120  $I_D(A)$ 

Figure 8. Normalized BV<sub>DSS</sub> vs temperature Figure 9. Static drain-source on resistance

Figure 10. Gate charge vs gate-source voltage Figure 11. Capacitance variations

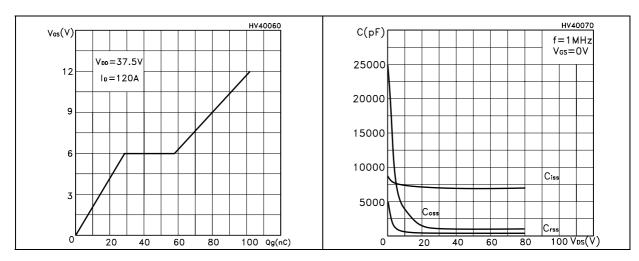


Figure 12. Normalized gate threshold voltage Figure 13. Normalized on resistance vs vs temperature temperature

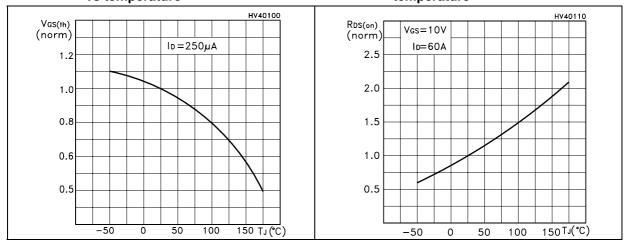
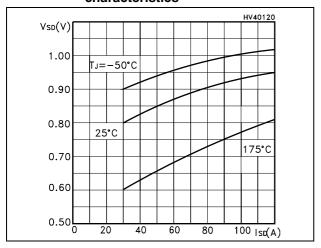


Figure 14. Source-drain diode forward characteristics



57

## 3 Test circuit

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

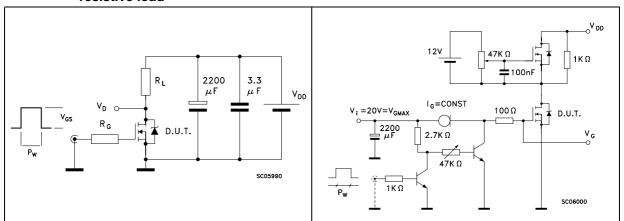


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

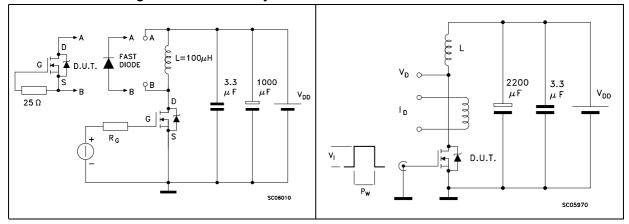
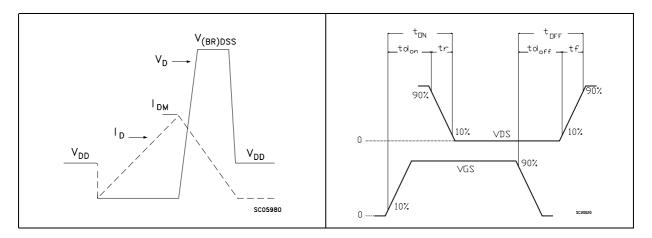


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform

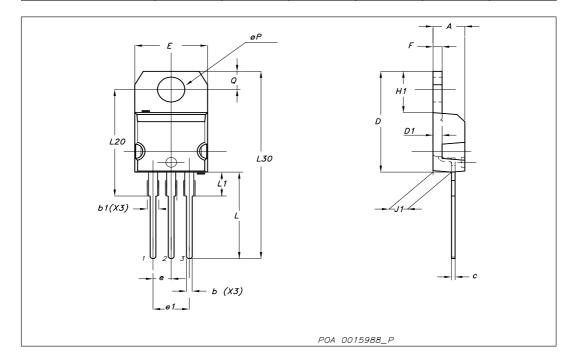


# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

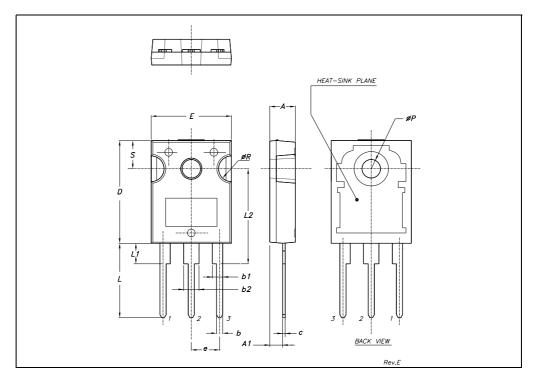
### TO-220 mechanical data

Dim		mm			inch	
Dim	Min	Тур	Max	Min	Тур	Max
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
Е	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



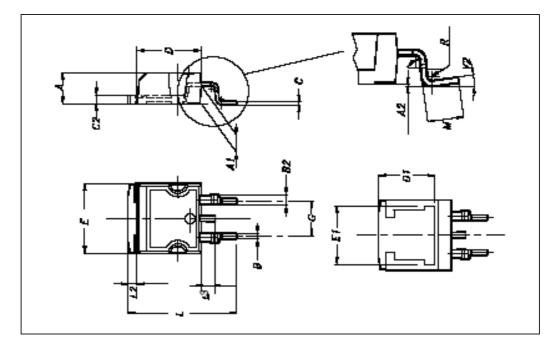
### **TO-247 MECHANICAL DATA**

DIM.		mm.			inch	
DIWI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



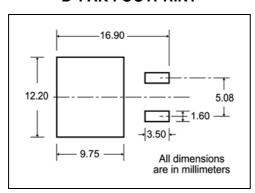
### D<sup>2</sup>PAK mechanical data

Dim		mm			inch	
Dim -	Min	Тур	Max	Min	Тур	Max
Α	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
В	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
С	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
Е	10		10.4	0.393		0.409
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.50		0.55
L3	1.4		1.75	0.055		0.68
М	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0°		4°			

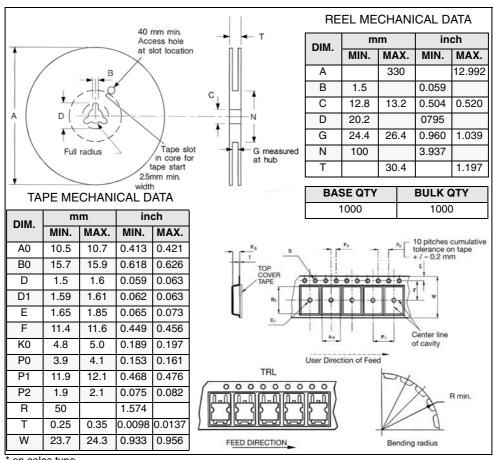


#### Packaging mechanical data 5

### D<sup>2</sup>PAK FOOTPRINT



#### **TAPE AND REEL SHIPMENT**



on sales type

# 6 Revision history

Table 8. Document revision history

Date	Revision	Changes
07-Feb-2007	1	First release
02-Oct-2007	2	New section has been added: Electrical characteristics (curves)

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

477